



NTE5570, NTE5572, & NTE5574 Silicon Controlled Rectifier (SCR) 125 Amp, TO94

Electrical Characteristics: (Maximum values @ $T_J = +125^\circ\text{C}$ unless otherwise specified)

Repetitive Peak Voltages, V_{DRM} & V_{RRM}

NTE5570	200V
NTE5572	600V
NTE5574	1200V

Non-Repetitive Peak Reverse Blocking Voltage, V_{RSM}

NTE5570	500V
NTE5572	900V
NTE5574	1300V

Average On-State Current (Half Sine Wave, 180° , $T_C = +85^\circ\text{C}$), $I_{\text{T(AV)}}$

RMS On-State Current (DC @ $T_C = +75^\circ\text{C}$), $I_{\text{T(RMS)}}$

Peak One-Cycle, Non-Repetitive Surge Current (10ms Duration, Sinusoidal Half Wave), I_{TSM}
No Voltage Reapplied

1900A

100% V_{RRM} Reapplied

1600A

Maximum I^2t for Fusing (10ms Duration, Sinusoidal Half Wave), I^2t

No Voltage Reapplied

18000A²sec

100% V_{RRM} Reapplied

12700A²sec

Peak Positive Gate Current (5ms Pulse Width), I_{GM}

3A

Peak Positive Gate Voltage (5ms Pulse Width), $+V_{\text{GM}}$

20V

Peak Negative Gate Voltage (5ms Pulse Width), $-V_{\text{GM}}$

10V

Average Gate Power ($f = 50\text{Hz}$, Duty Cycle = 50%), P_G

3W

Peak Gate Power (50ms Pulse Width), P_{GM}

12W

Rate of Rise of Off-State Voltage (Exponential to 67% Rated V_{DRM}), dv/dt

500V/ μs

Rate of Rise of ON-State Current, di/dt

(Gate Drive 20V, 65Ω , with $t_r = 0.5\mu\text{s}$, V_d = Rated V_{DRM} , $I_{\text{TM}} = 2 \times di/dt$ snubber $0.2\mu\text{F}$)

Non-Repetitive

300A/ μs

Typical Delay Time, t_d

(Gate Pulse: 10V, 15Ω Source, $t_p = 6\mu\text{s}$, $t_r = 0.1\mu\text{s}$, V_d = rated V_{DRM} , $I_{\text{TM}} = 50\text{A}$)

1 μs

Typical Turn-On Time, t_q

($I_{\text{TM}} = 50\text{A}$, $di/dt = -5\text{A}/\mu\text{s}$ min, $V_R = 50\text{V}$, $dv/dt = 20\text{V}/\mu\text{s}$, Gate Bias: 0V 25Ω , $t_p = 500\mu\text{s}$)

110 μs

On-State Voltage ($I_{\text{PK}} = 250\text{A}$, 10ms Sine Pulse), V_{TM}

1.6V

Repetitive Peak Off-State Current (At V_{DRM}), I_{DRM}

15mA

Repetitive Peak Reverse Current (At V_{RRM}), I_{RRM}

15mA

Maximum Gate Current Required to Trigger, I_{GT}

(6V Anode-to-Cathode Applied, $T_J = +25^\circ\text{C}$)

120mA

Maximum Gate Voltage Required to Trigger, V_{GT}

(6V Anode-to-Cathode Applied, $T_J = +25^\circ\text{C}$)

2.5V

Maximum Holding (Anode Supply 12V Resistive Load, $T_J = +25^\circ\text{C}$), I_H

150mA

Maximum Gate Voltage which will not Trigger any Device, V_{GD}

0.25V

Electrical Characteristics (Cont'd):	(Maximum values @ $T_J = +125^\circ\text{C}$ unless otherwise specified)
Operating Temperature Range, T_J	-40° to +125°C
Storage Temperature Range, T_{stg}	-40° to +150°C
Thermal Resistance, Junction-to-Case (DC Operation), R_{tnJC}	0.3°C/W
Thermal Resistance, Case-to-Heat Sink, $R_{\text{thC-HS}}$ (Mounting Surface Smooth, Flat, and Greased)	0.1°C/W

